

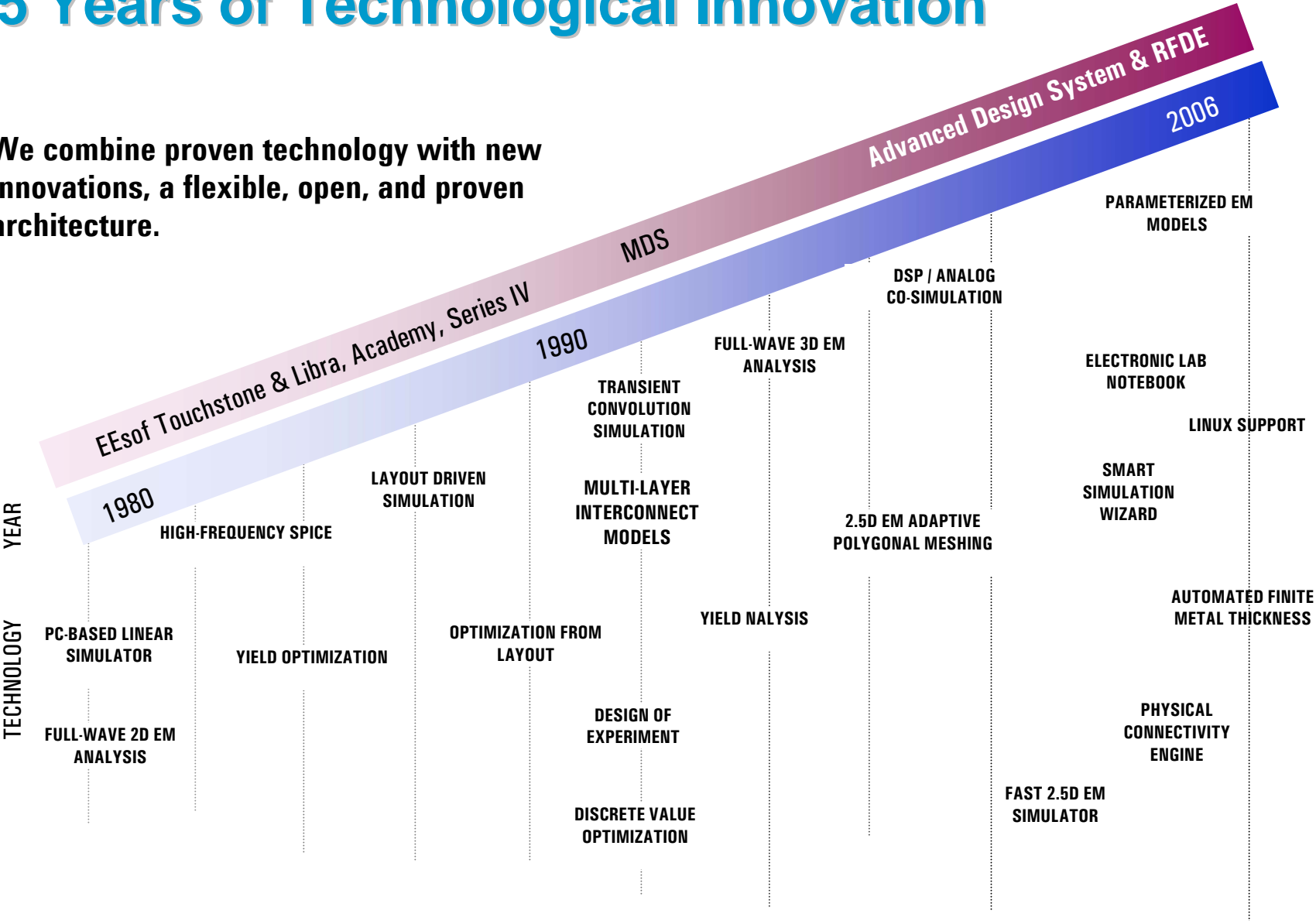
# 3DEM, Simulation and Measurement Advances for 2006

Expands SI Horizons



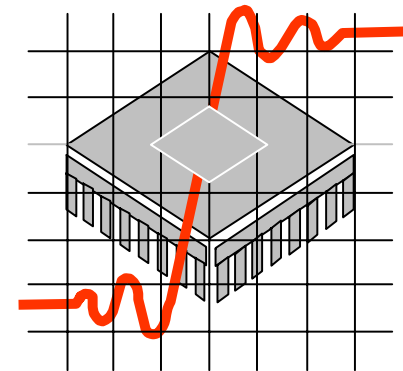
# 25 Years of Technological Innovation

We combine proven technology with new innovations, a flexible, open, and proven architecture.



# Digital modeling systems under stress

- Higher data rate
- Fast edge rate
- Smaller noise margins
- Thinner and longer lines
- Clock distribution
- Differential systems
- Impedance control, terminations
- Imperfect power and ground
- High density connector and package



# What's in ADS for High Speed Digital

## *"Expands SI Horizon"*

### 1. Leading Simulation Technology

solves new problems and gives you a design advantage

### 2. Accurate Models

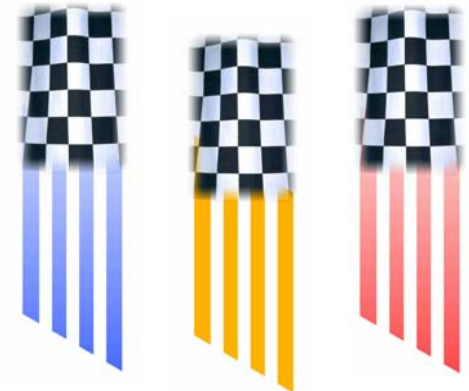
conquer existing problems so you are confident that designs will work the first time

### 3. Accessibility & Flow Integration

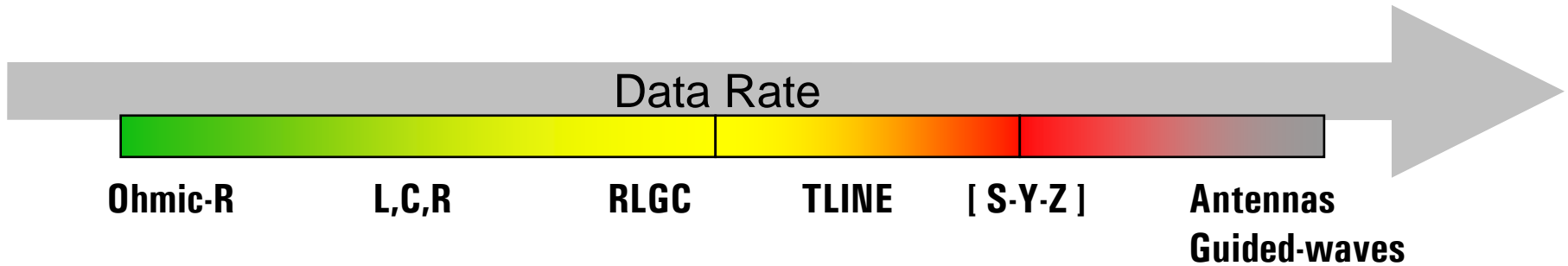
within your Design Flow puts Agilent tools closer to the design problems

### 4. Usability and Quality

frees your creativity and makes the most of your effort



# Distributed & EM models: Why you may not have needed them before ?

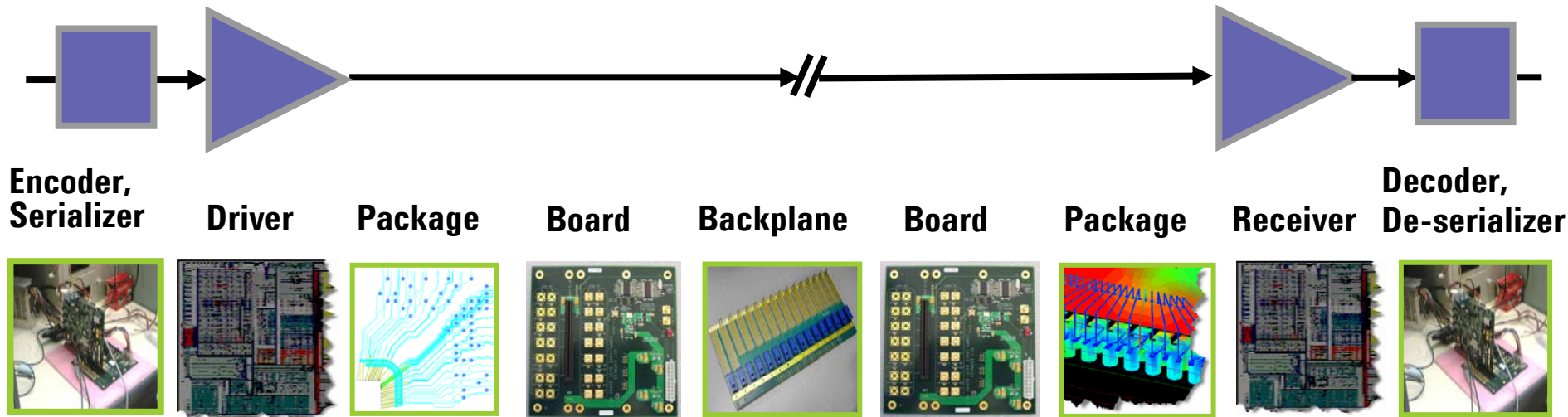


Lumped-element models for length  $\ll \lambda$

Quasi-static distributed element models for length  $> \lambda/10$

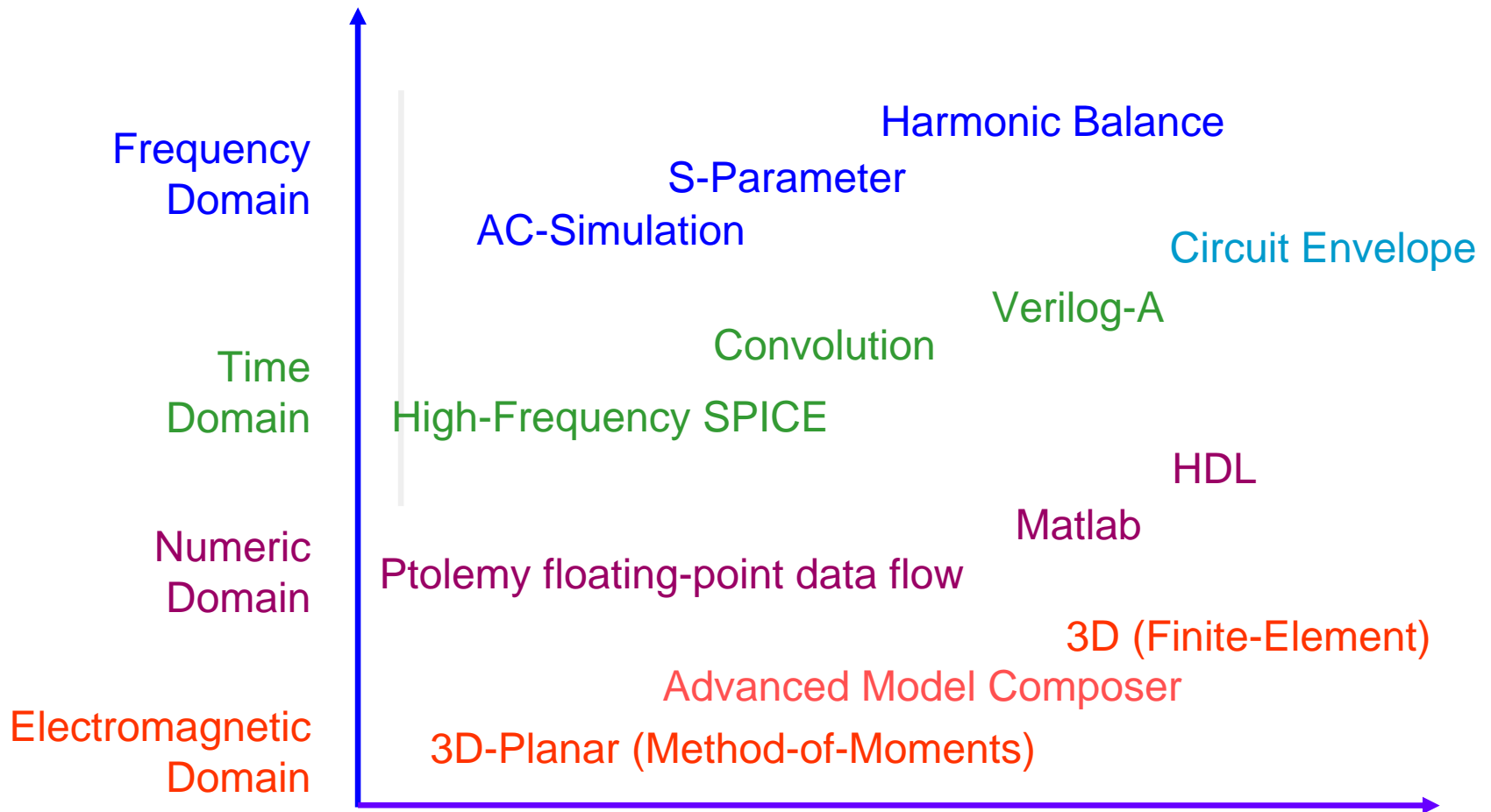
- Transmission line effects prevail at sub-nanosecond rise-times
  - Impedance, delay, loss, dispersion, crosstalk, etc.
- Full-wave electromagnetic models for width  $> \lambda/2$

# High Speed Digital Channel Design Expands SI Horizon

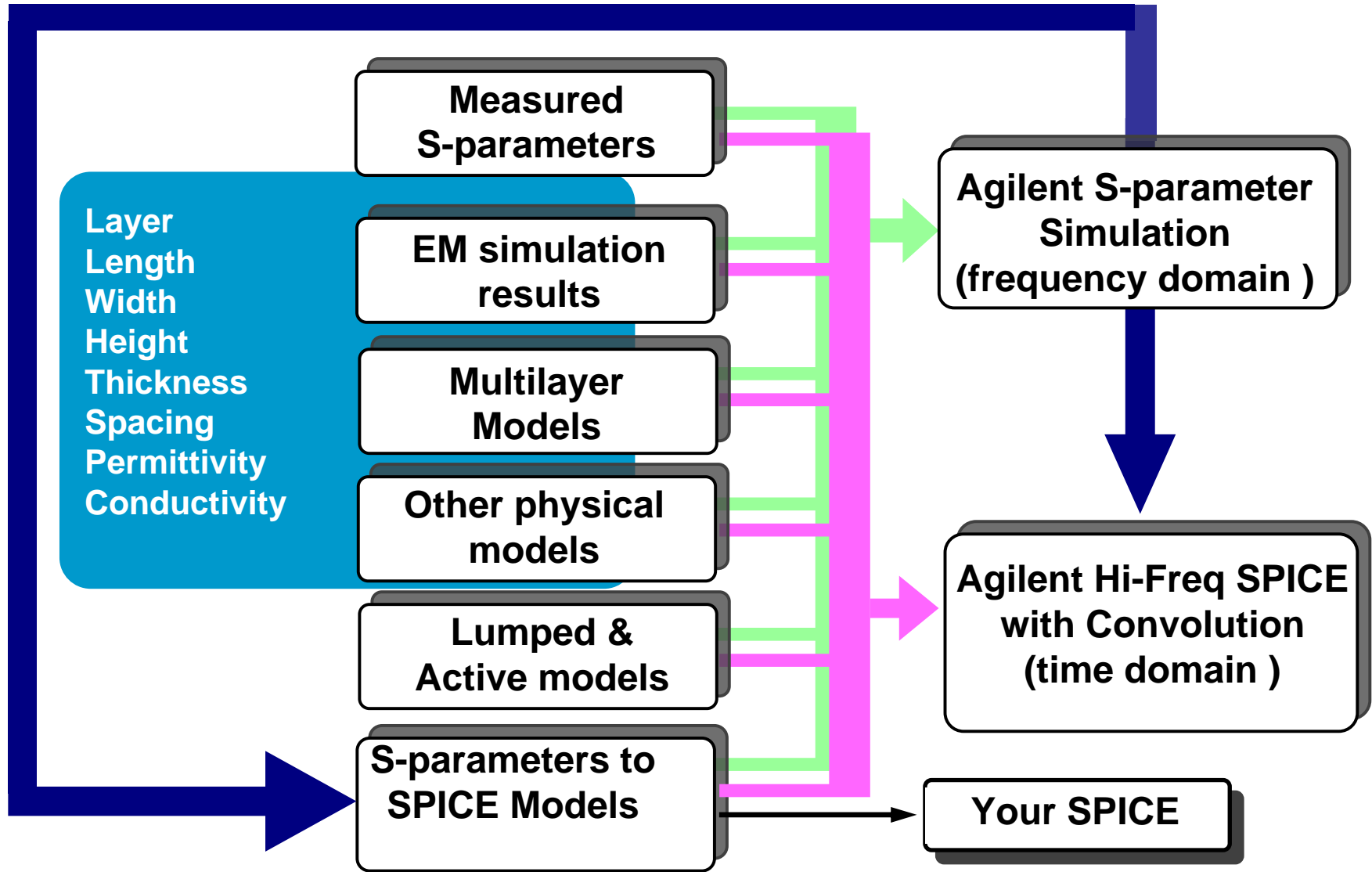


- ➔ ADS supports all implementation domains (IC, Module, Board)
- ➔ ADS can analyze the full digital channel – data in to data out
- ➔ Integrated data models and simulation technology

# Combining Simulation Technologies

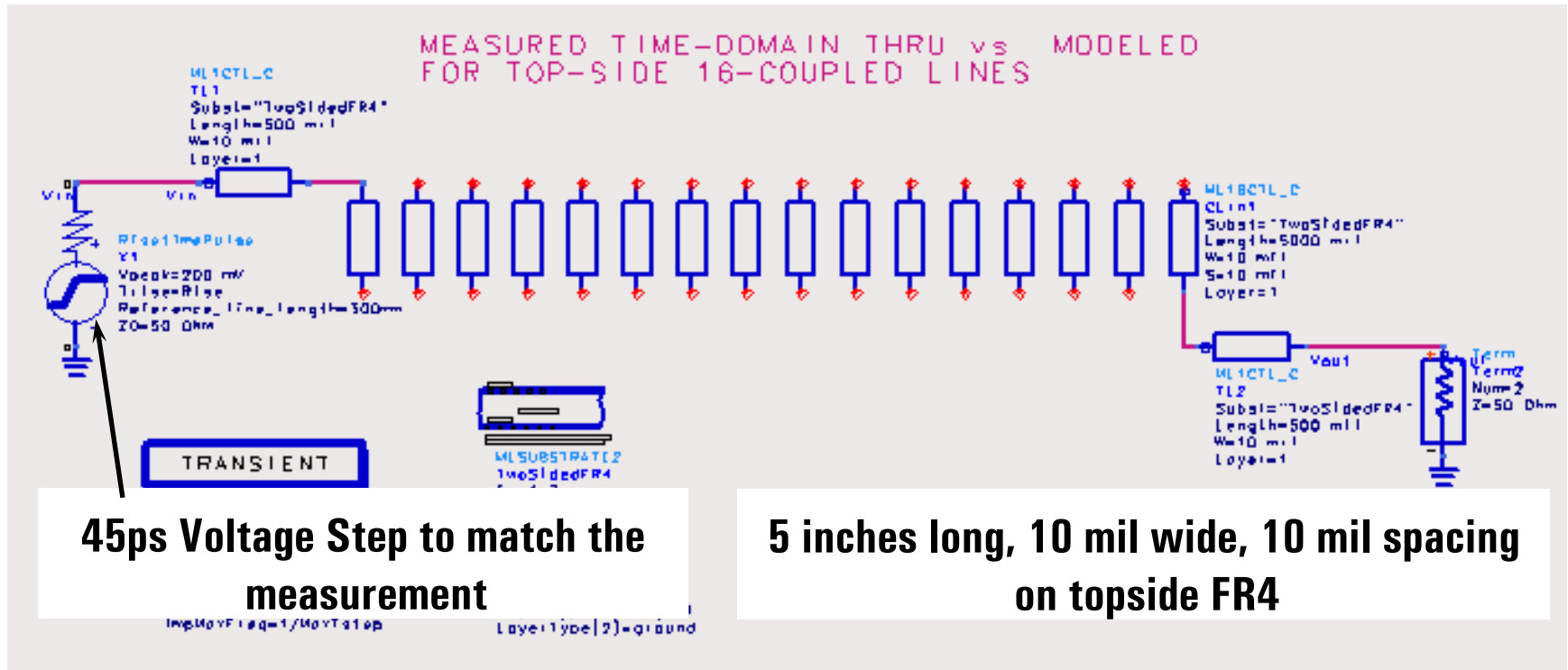


# Analog Design Flow within ADS

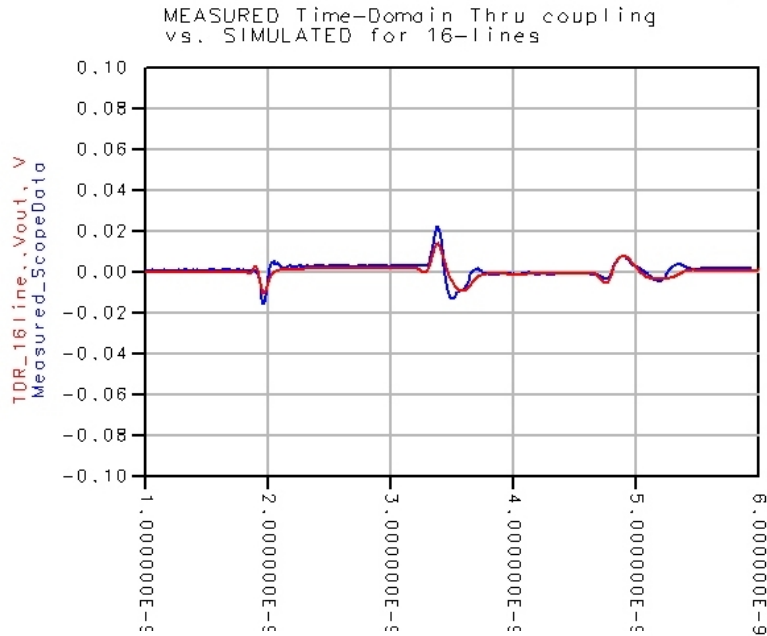




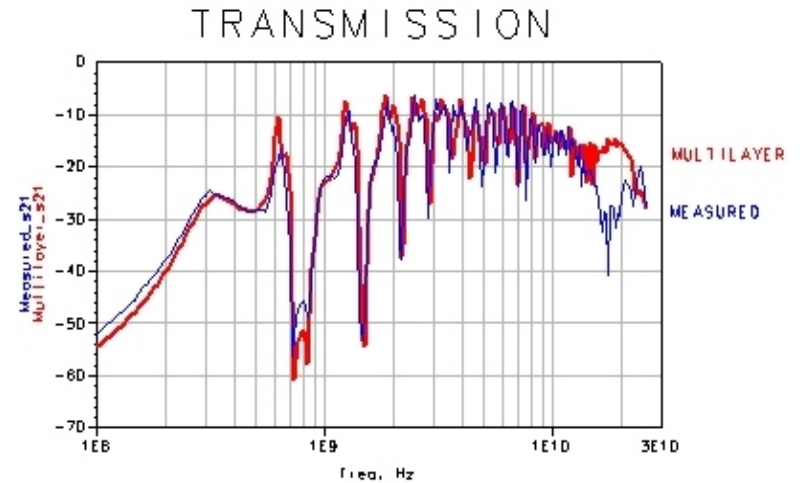
# Measured vs. modeled for the 16-coupled line model



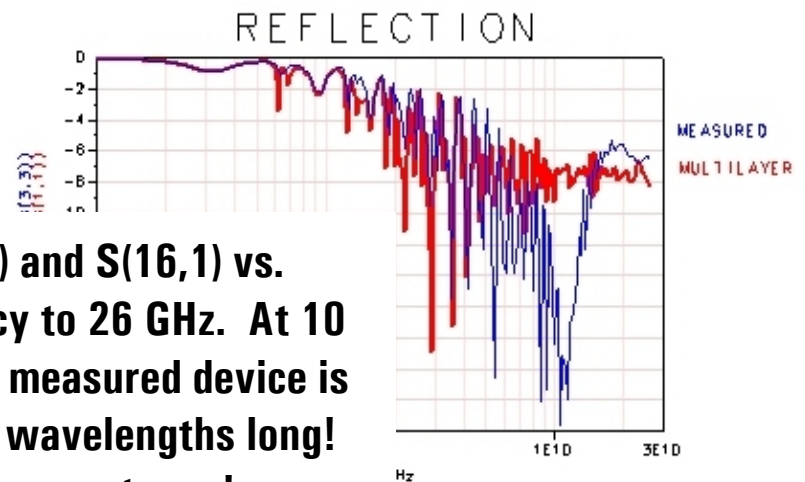
# Measured vs. modeled for the 16-coupled line model



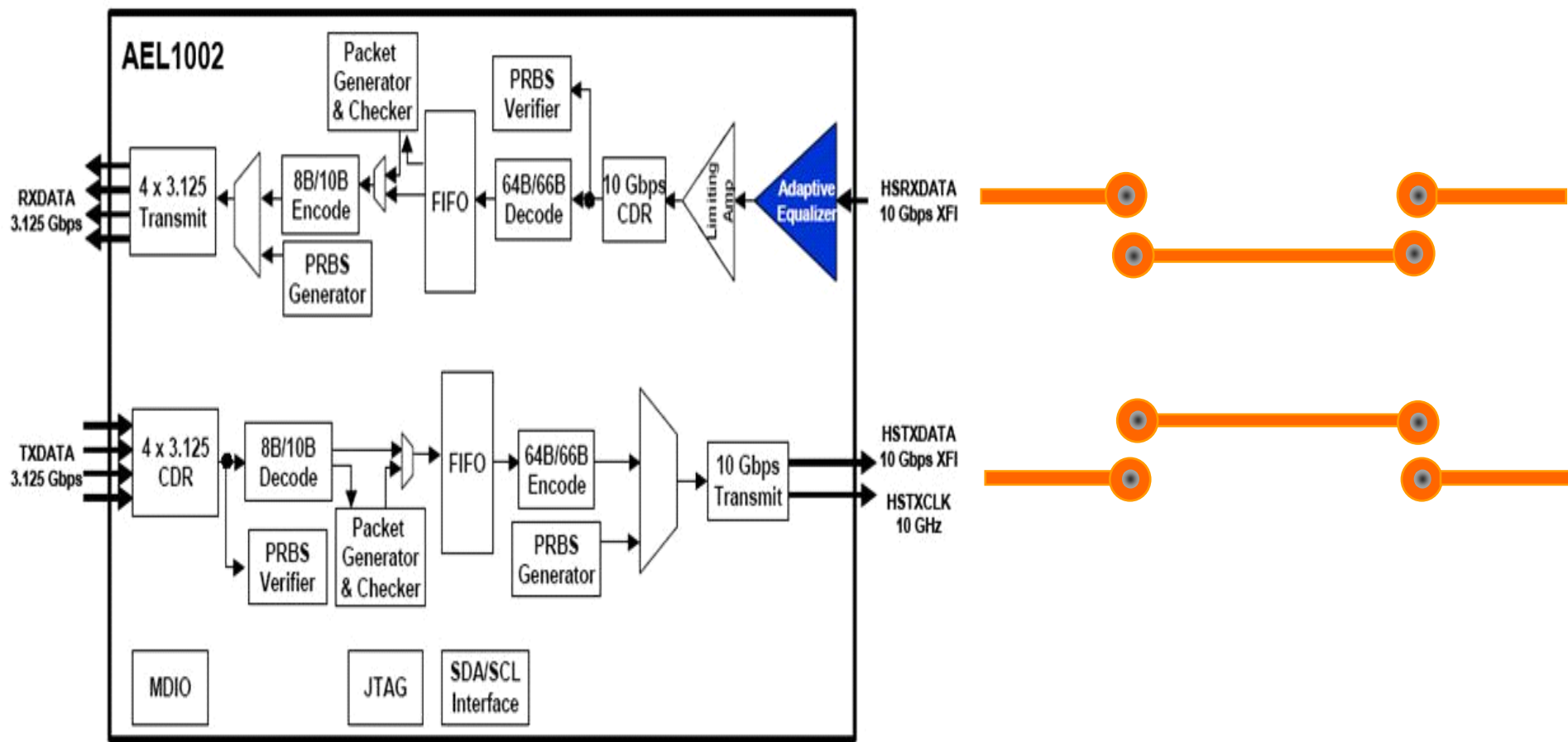
**Time-domain Thru measurement vs. simulated for the crosstalk between traces 1 & 16 (2% peak)**



**S(1,1) and S(16,1) vs. frequency to 26 GHz. At 10 GHz, the measured device is about 6 wavelengths long! It's an antenna!**



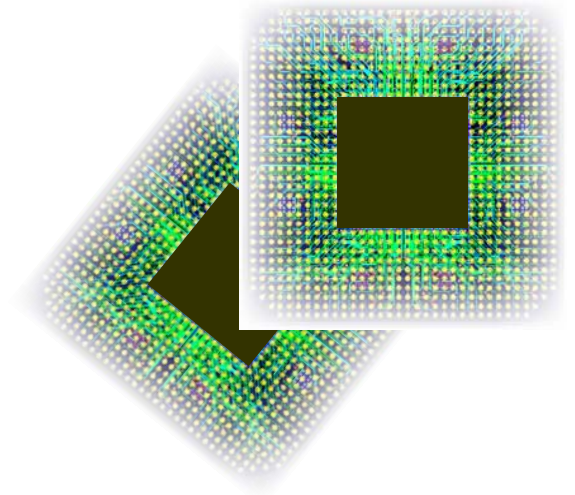
# High Speed Digital Design Using ADS



# Serial Link System Level Modeling

## A new challenge for Signal Integrity Engineer

- High data rate
- Electrically long Backplane and Cables
- Eye pattern closed at receive end



### Design Requirements

- Decision Feedback Equalizer
- Feed Forward Equalizer
- Clock and Data Recovery
- Gain Controls
- Integrate **SERDES** models provided by IC vendors

Is time domain simulator sufficient?

**SERDES** model availability & format?

# Analog Components of a Channel

Transmission Lines

Via Holes

High Speed Connectors

Package

I/O – IBIS models and Transistor level models

**Best represented  
in Time &  
Frequency  
domain**

# Behavior Components in a Channel

Decision Feedback Equalizer

Feed Forward Equalizer

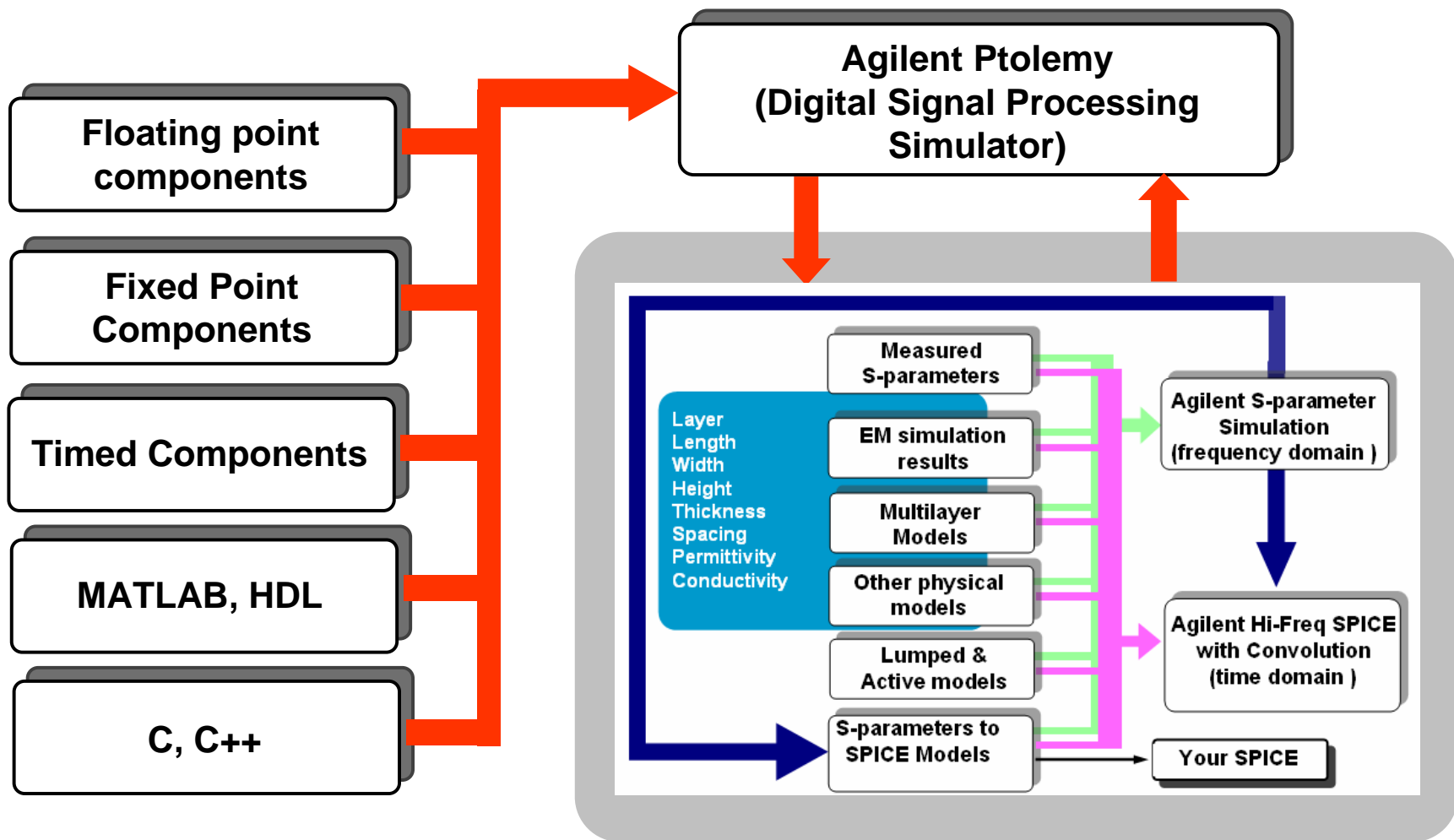
Clock and Data Recovery

Gain Controls

SERDES Models

**Best represented  
in Numeric  
domain**

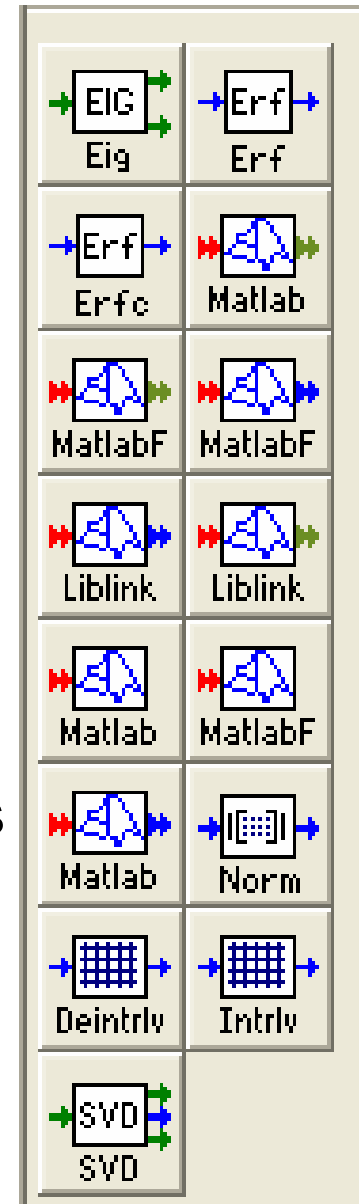
# ADS Co-Simulation Design Flow with High Frequency SPICE



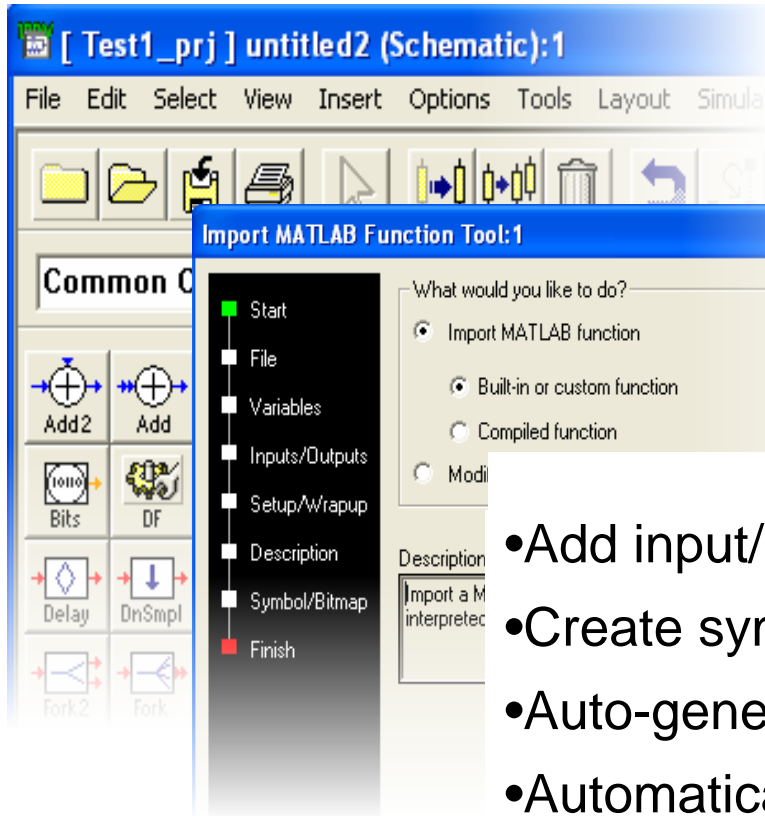
# Matlab Co-simulation in ADS

MATLAB Co-simulation is increasingly becoming important for SI design community because:

- Integrate existing IP
- Fast implementation of behavioral models
- Familiarity with the tool and comfort zone
- SERDES models - available as MATLAB models



# MATLAB Import Wizard in ADS2006A

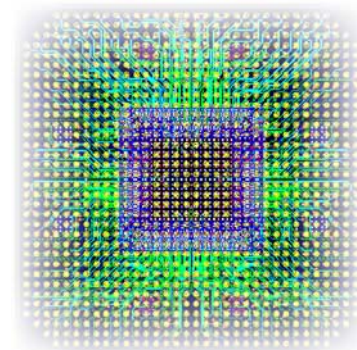


- Add input/output ports
- Create symbol, palettes, and bitmaps..
- Auto-generate ADS library components
- Automatically setup Multi-rate operations
- Allow iterative update of generated MATLAB model
- Compiled MATLAB model support



# ADS High Frequency SPICE Simulation Technology

Gives you confidence that your design will work right, the first time



# Passivity and Causality

**Passive System** – A Passive system is the one which can not produce energy

Insufficient attention to measurements or calibration

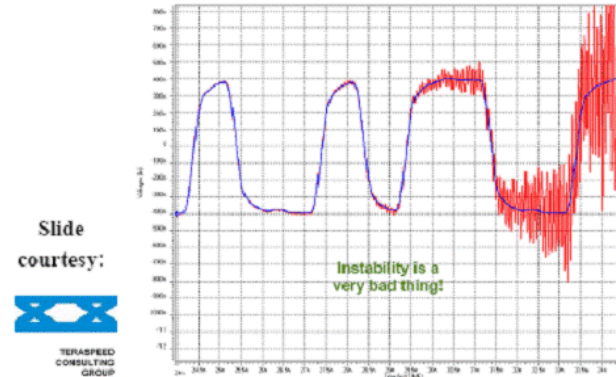
- Interconnects do not amplify signals
- Even if individual measurements are passive, combined system measurements can be non passive

**Causal System** – A Causal system in the one whose output at any time depends upon the past inputs and not on future inputs

*Passive system needs to be Causal. If a system is non-Causal, it can not be passive*

Behavioral Modeling

Lack of Passivity Produces Oscillations



# S-Parameters and many SPICE Simulators

- Difficult simulation setup
- Convergence issues
- Questionable accuracy
- Passivity issues
- Causality issues

## ADS High-Frequency SPICE with Convolution

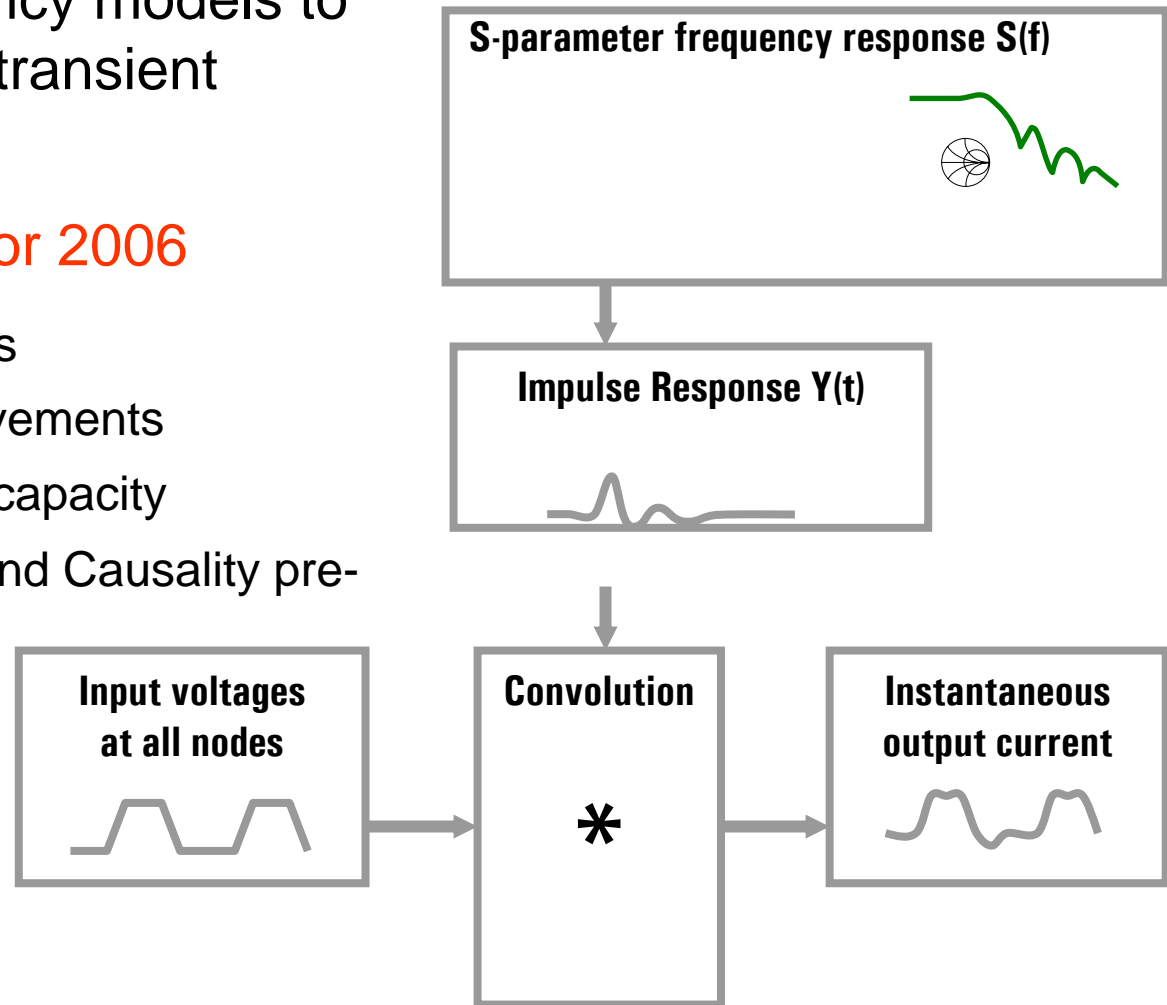
- SPICE developed as an internal tool since 1970 (date)
- High-Frequency SPICE commercialized in 1983 (date)
- Convolution simulator commercialized in 1992
- **Fast and Accurate** time-domain simulation of S-parameters

# Convolution Simulator in ADS

Allows high-frequency models to be used directly in transient simulations

## EEs of R&D focus for 2006

- Speed improvements
- Convergence improvements
- Increase simulation capacity
- Enhance Passivity and Causality preconditioner



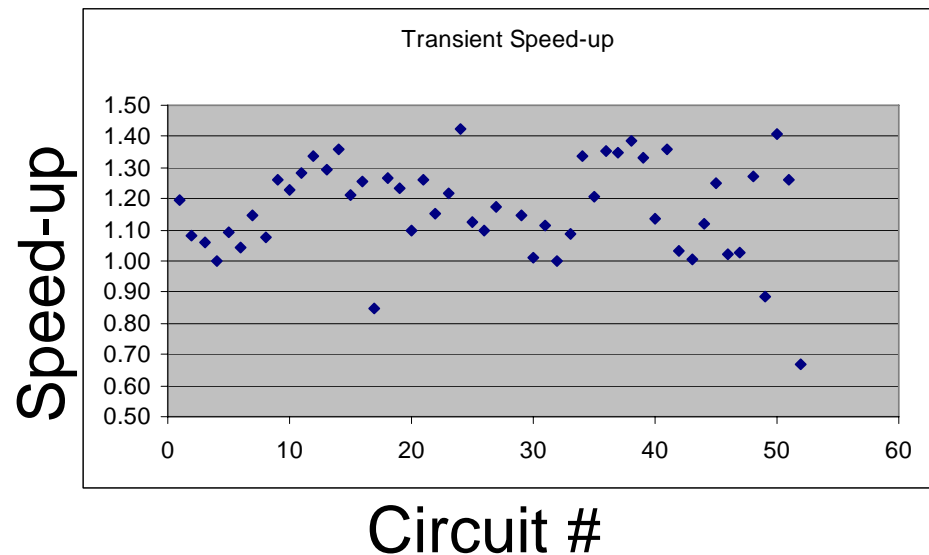
# Strong focus on High-Frequency SPICE



High-Frequency SPICE is slower than H-SPICE and SPECTRE

## The October release is 30% faster

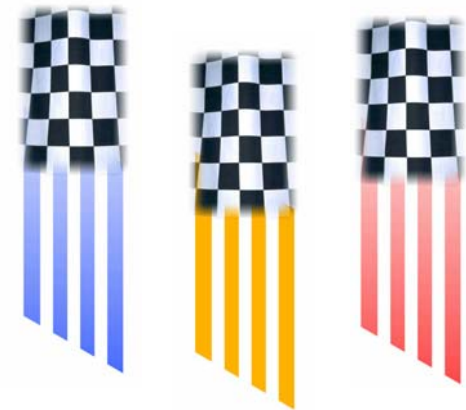
- *Early Access Code available*
- Algorithmic improvements
- Device optimization
- Code optimization



# Convolution Technology Advances

New engine for robust handling of S-parameter data in the time domain, employing:

- Break-through technology for built-in causality correction
- Optional passivity correction



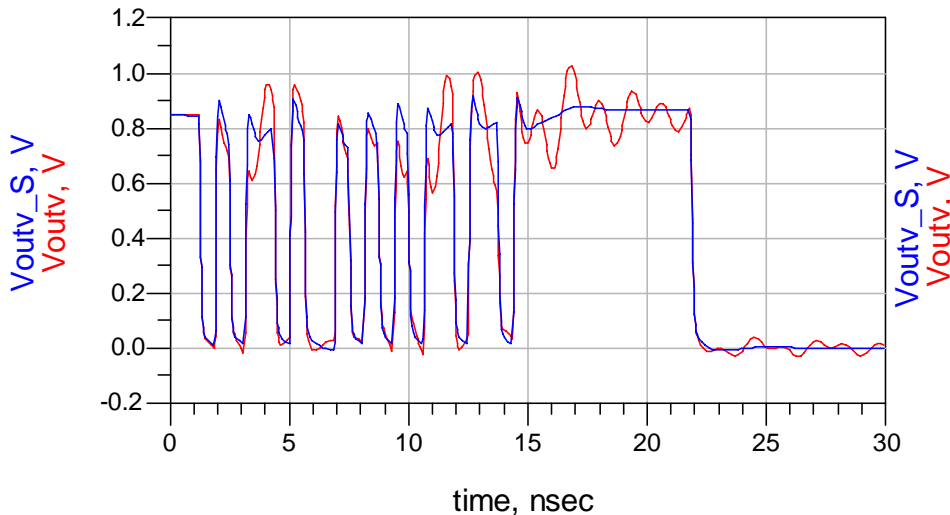
# Convolution Technology Improvements

## High Accuracy

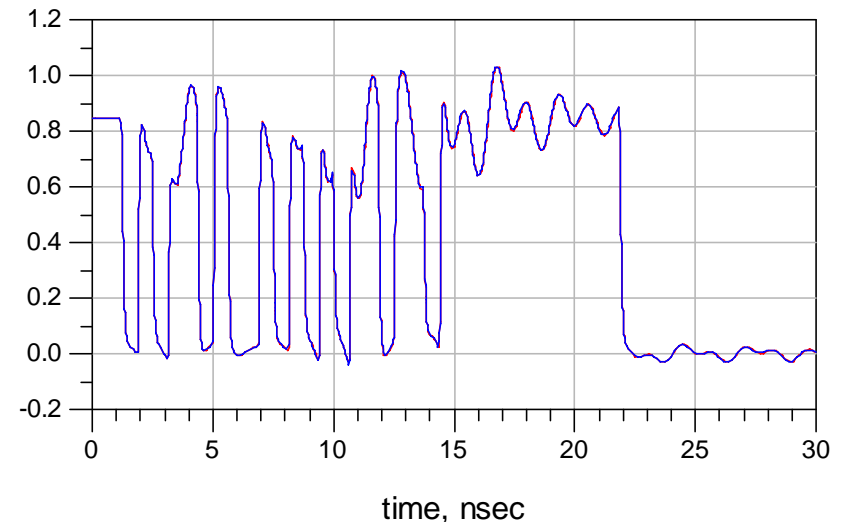
Example:

Low impedance power/ground plane( mOhms) into 50 Ohm reference impedance

Reference Results Existing Engine



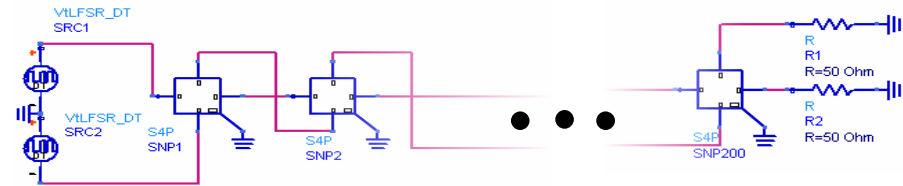
Reference Results New Engine



# Convolution Technology Improvements

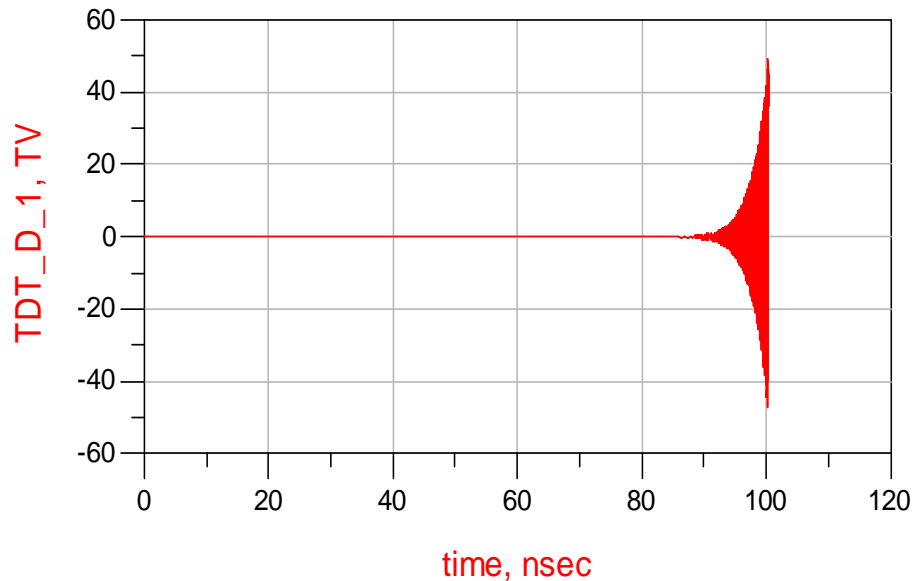
## Robustness

Example:

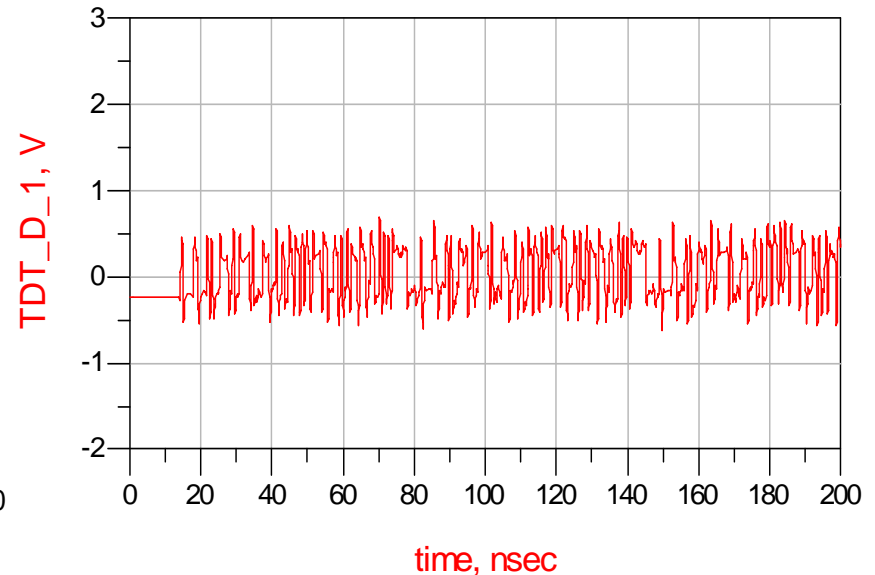


- 200 identical, 4-port s-parameter devices in cascade
- Each s-parameter file slightly **non-passive**

Existing Engine



New Engine





# Why Digital Designer needs Electromagnetic Simulator?

- Convenient and inexpensive way to evaluate arbitrary structure performance.
- What if analysis is possible with inexpensive iterations
- Expands varieties and range of analytical models
- Overcome limitation of analytical models

## Two personas

### **Signal integrity gurus who creates design rule**

- Requires simulation tool flexibility and power
- Accurate EM simulation
- Requirement to model electrically small structures

### **Post layout design verification**

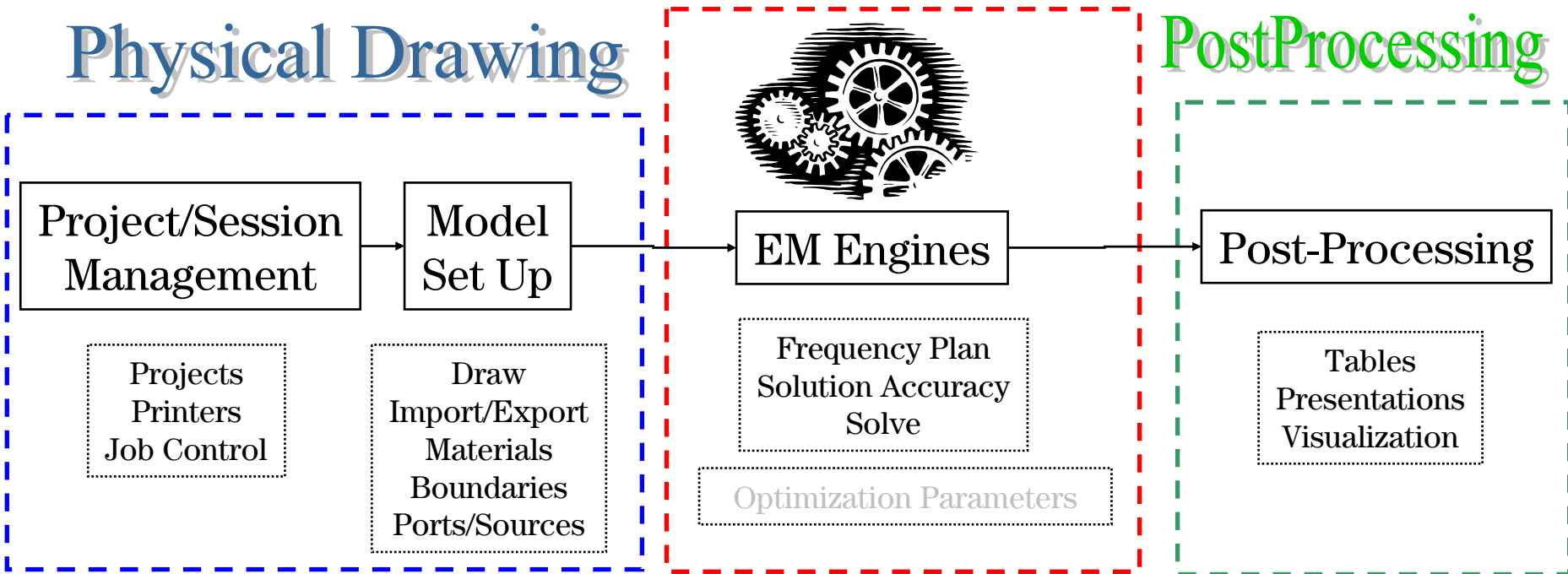
- Requires high capacity EM solver
- Approximate EM solutions
- Single click button operations

# Electromagnetic Simulation

## EM Engine

## Physical Drawing

## PostProcessing



- **Momentum Simulator**
- **EMDS ( Electromagnetic Design System)**

# Momentum 3D Planar Electromagnetic Simulator

Momentum is a 3-D planar fullwave electromagnetic solver based on Method-of-Moments

- “3-D planar” because it assumes metal lies in distinct planes between slabs of dielectric, possibly connected with vias

Calculates S-parameters for metallization on PCB's, MCM's, IC's and Package

- S-parameters are then used directly in circuit simulations or to create an equivalent circuit model
- Can handle imperfect ground planes, vias, semiconductors, lossy dielectrics, skin effect losses, dispersion, radiation and surface-wave effects
- Static solvers are faster but miss many fullwave effects

# Electromagnetic Simulation Flow

Allegro/Gerber/Mentor/GDSII/Mask...

.sat File Import  
(To be released in Oct'2006)

ADS Layout

EMDS Interface

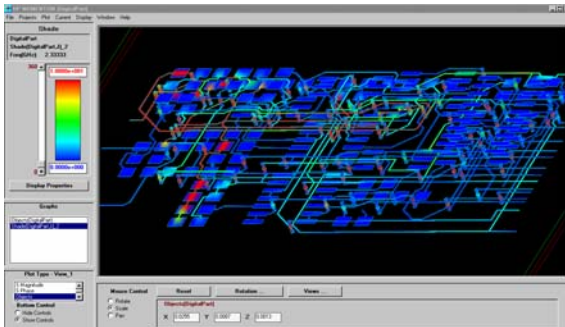
Momentum

EMDS

S-Parameters

Agilent Broadband  
SPICE Model  
Generator

Lumped Equivalent



— Enhancements in ADS2006A

# Agilent's Broadband SPICE Model Generator

Solves new challenges  
***“Expands SI Horizon”***



# Preview: Agilent Broadband SPICE Model Generator *(January 2007)*

- Takes an S-parameter frequency response and outputs a lumped equivalent SPICE netlist fragment
- S-parameters can come from simulations, EM, or measurements
- Helps you to export models for connectors, packages, and interconnects to your customers and other designers
- You can continue to work at higher frequencies with deeper understanding
- Helps extend the simulation frequency range for band limited data

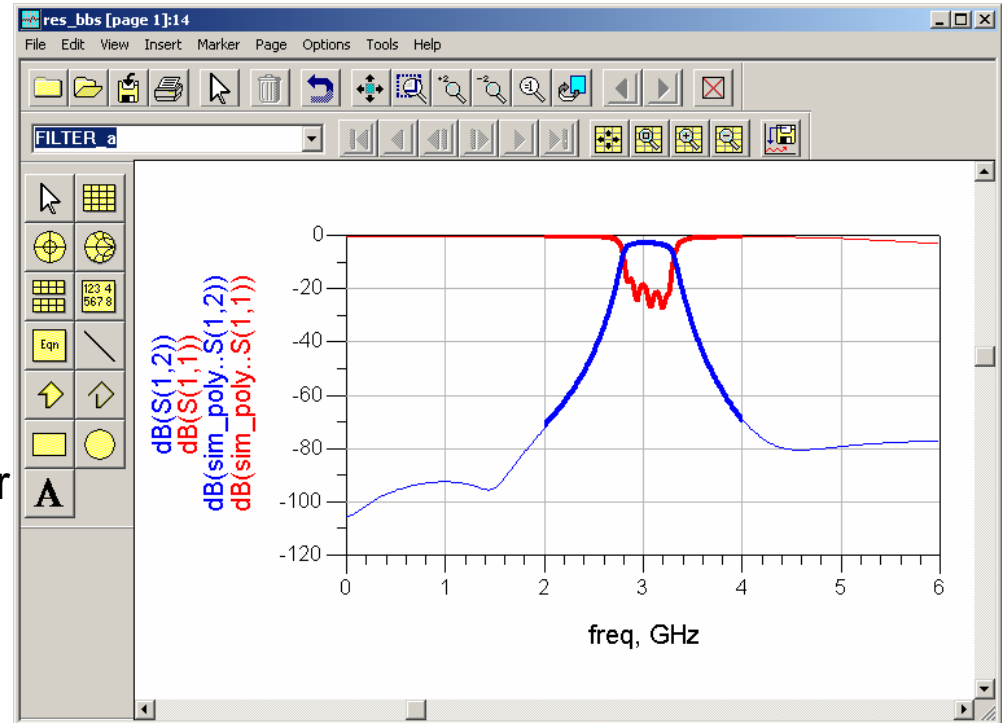
## Typical applications:

- RFIC: data for spiral inductors, IC packages, DUT boards
- Signal integrity and high-speed interconnect applications
- Wideband physical structures, and connectors

# Preview: the E4687 Agilent's Broadband SPICE Model Generator (January 2007)

## What it does:

- Takes in frequency-domain S/Y/Z-parameters
- Outputs a fast, well-behaved SPICE equivalent circuit
  - Berkeley Spice 2G6 & 3, rational polynomials, and other native formats



# Design Flow Integration

## Allegro → ADS

Solves new challenges  
***“Expands SI Horizon”***



Shipment Date- January 2007  
(ADS 2006A Update 1)



# Allegro export interface

**Menu pick to start**

**Option to set up for Momentum**

**Other ways to select nets**

**Export to ADS**

Net Names

- A1
- A2
- A3
- A4
- A5
- A6
- A7
- A8
- A9
- A10
- A11
- A12
- A13
- A14
- A15
- A16
- A17
- A18

Select All

Unselect All

Create layer mapping file

List all nets in design

Use Regular Expression filter

Filter:

Add nets to list with Select

Clear Select

Star Select

Arc Resolution (deg): 15.0

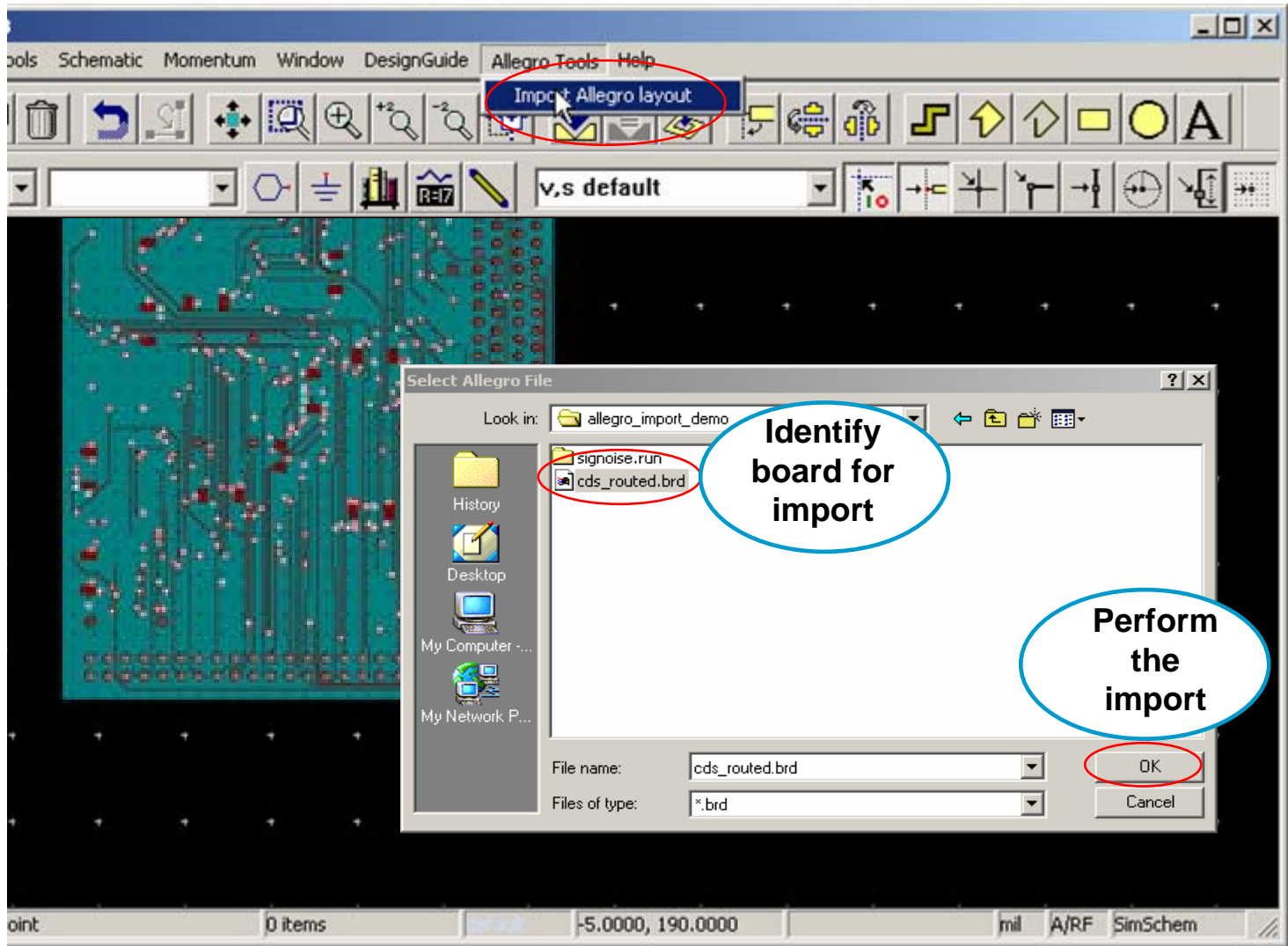
Export All

Export Selected

Cancel

Select nets for export to ADS

# ADS import interface



# User loads exported Momentum substrate information

**Dielectric layers automatically defined**

**Drawing layer mapped, including vias**

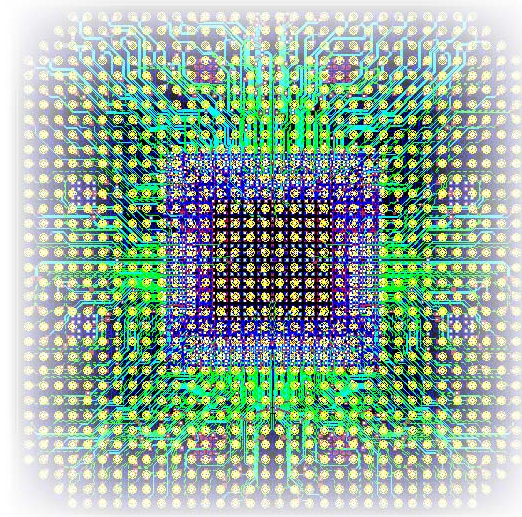
# Extended Performance in 2006

- Conquers existing problems faster and more effectively
- Gives you confidence that your design will work right, the first time.

*Simulator improvements*

*64-bit OS support*

*Other core improvements  
to PDE, Data Display,  
Layout, Simulators*



# Momentum –

## Continued enhancements for complex metallization

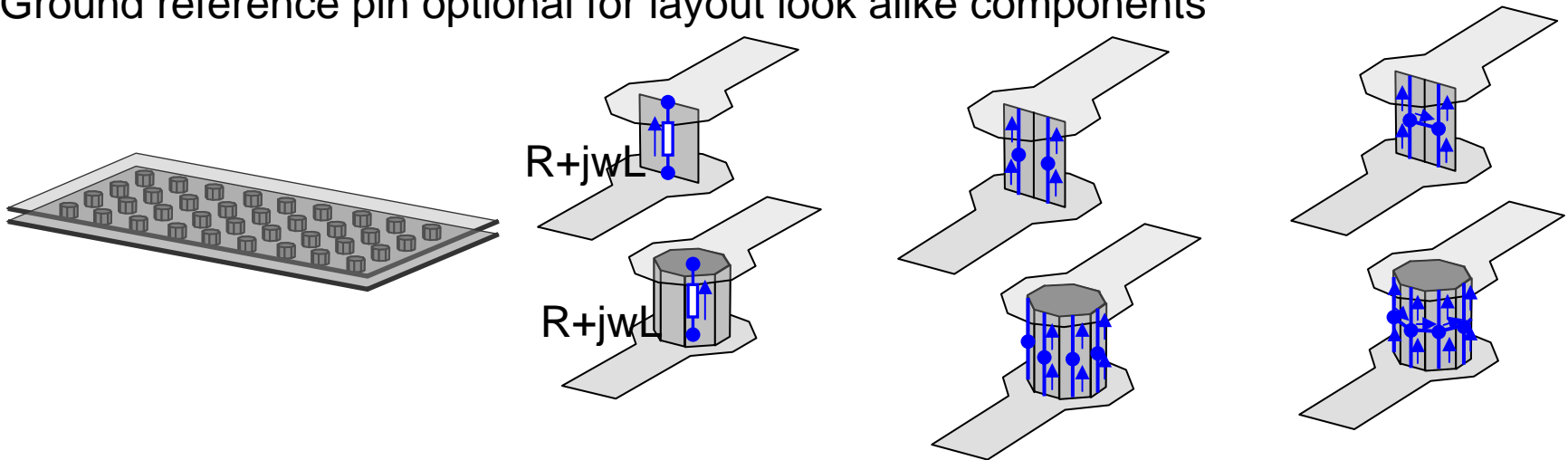
Improved Via modeling

- Lumped via model
- 2D via model (pre-ADS2006A model)
- 3D distributed model

64-bits solver handles larger problems

Enhanced port editing

Ground reference pin optional for layout look alike components



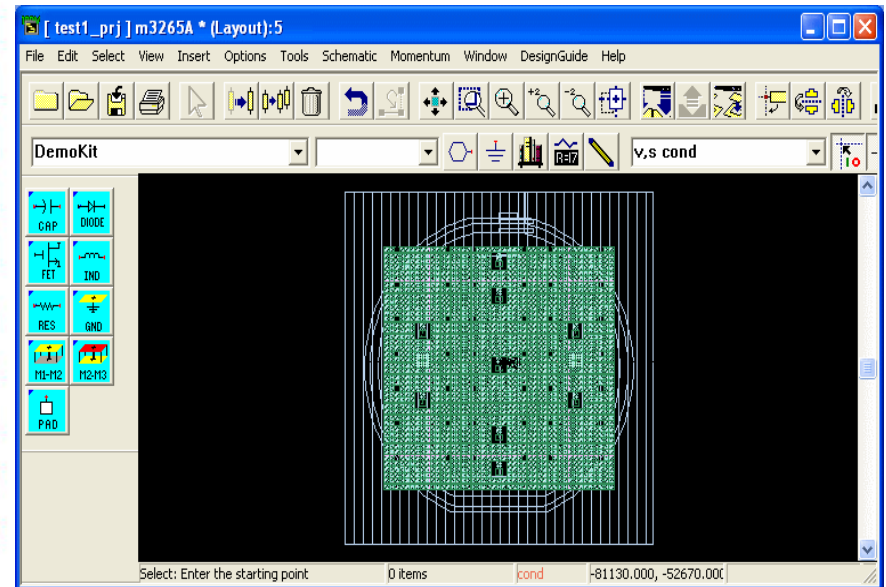
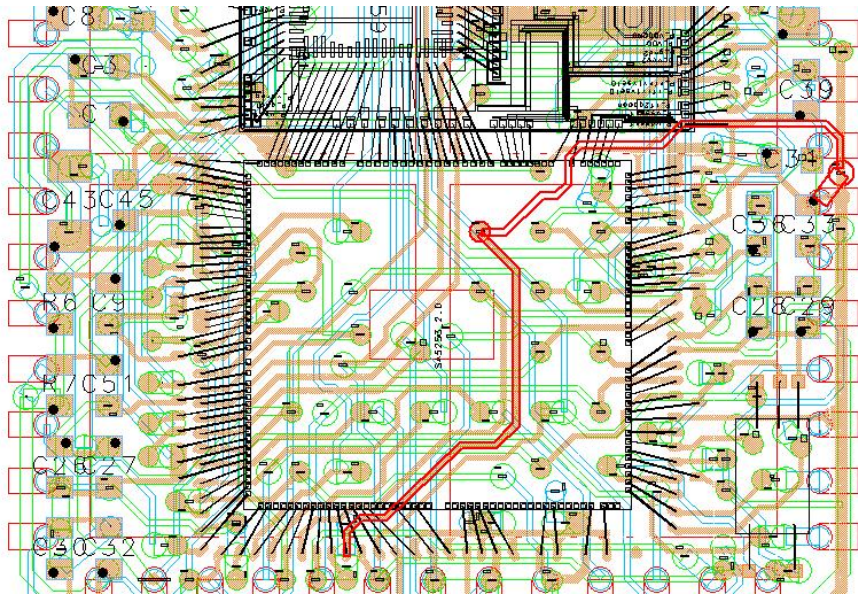


# Layout – Performance gains with the new Physical Connectivity Engine (PCE)

Significant performance gain for PCE for large designs.

ADS 2005A could be slow when opening a large design for the first time →  
2006A: almost no overhead for the connectivity engine

2005A User Interface to disable the connectivity engine was difficult  
→ 2006A: easy “Preference” setting, but not necessary to disable

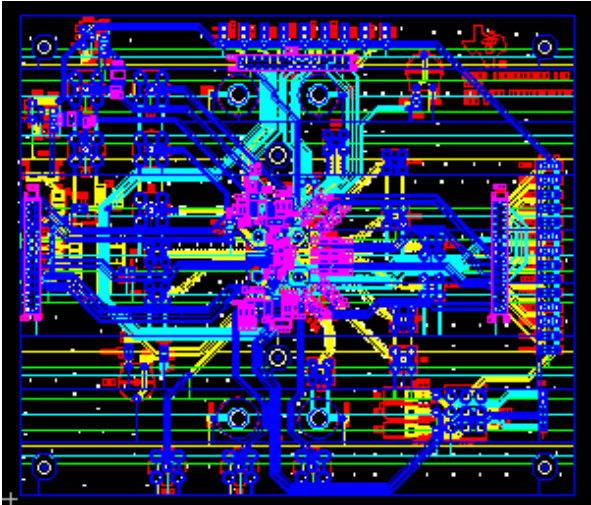


# Layout – Performance gains with connectivity

## Flatten design

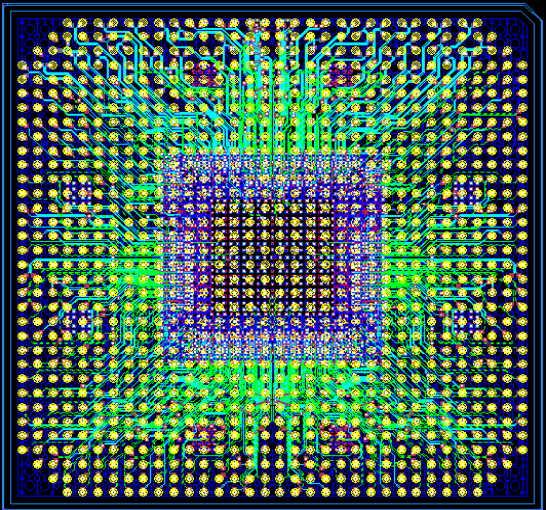
2006A Load time: **1.5sec** (0.5sec if PCE OFF)

2005A Load time: 5sec



## BGA Package

Load time : **8X** faster in ADS2006A as compared to ADS2005A

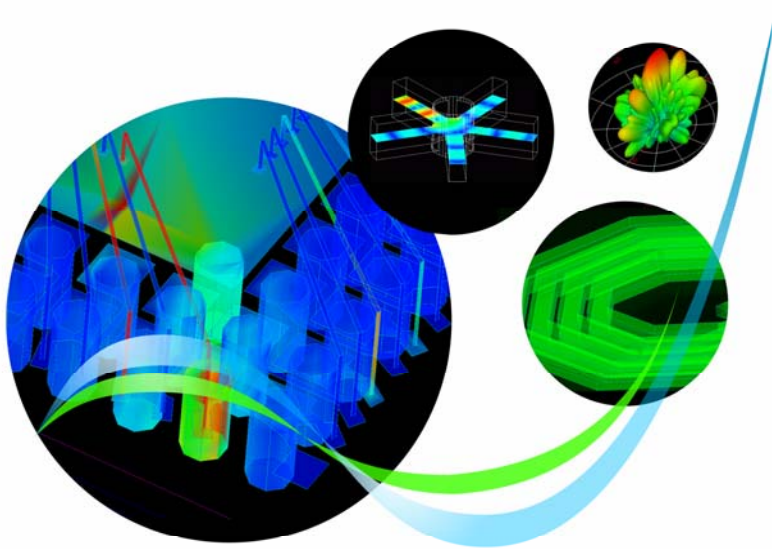


Design	Connectivity off (load time)	Connectivity on, 2006A	Connectivity on, 2005A
1	< 1 sec	< 1sec, 52MB	2.3sec, 69MB
2	4 sec	5sec, 52MB	20sec, 216MB
3	30 sec	35sec, 67MB	load failed
4	5 sec	6sec, 55MB	16sec, 110MB
5	12 sec	12sec, 53MB	15sec, 69MB
6	22 sec	23sec, 54MB	>>120 sec, 300MB
7	72 sec	78sec, 130MB	1200sec, 630MB
8	9 sec	12sec, 13MB	17sec, 40MB

# Electromagnetic Design System (EMDS)

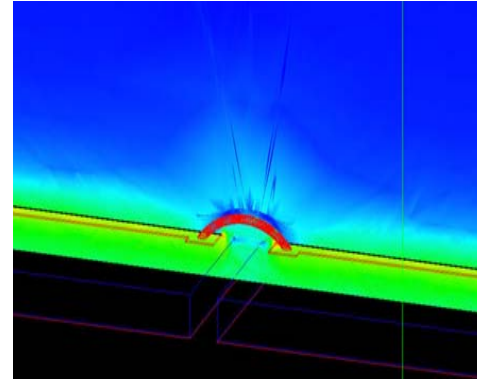
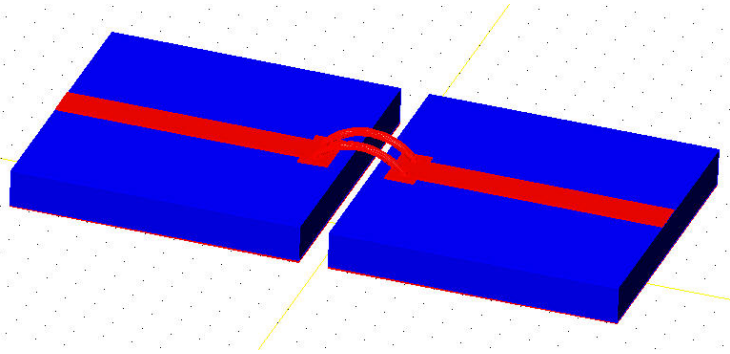
For engineers designing:

- Vias
- Packages
- Wire-bonds
- Transitions to connectors
- High-frequency interconnects
- Un-intentional antennas





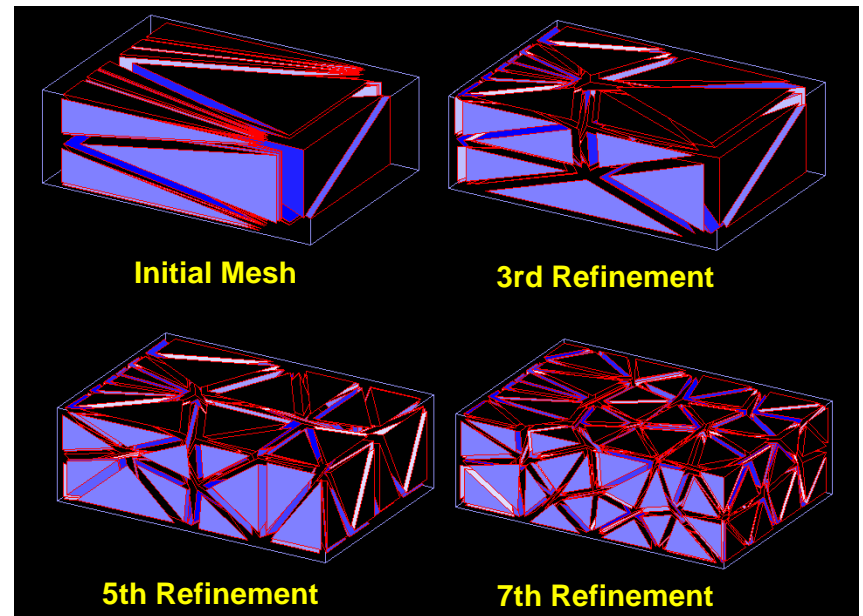
# EMDS – Agilent's 3D Full Wave EM simulator



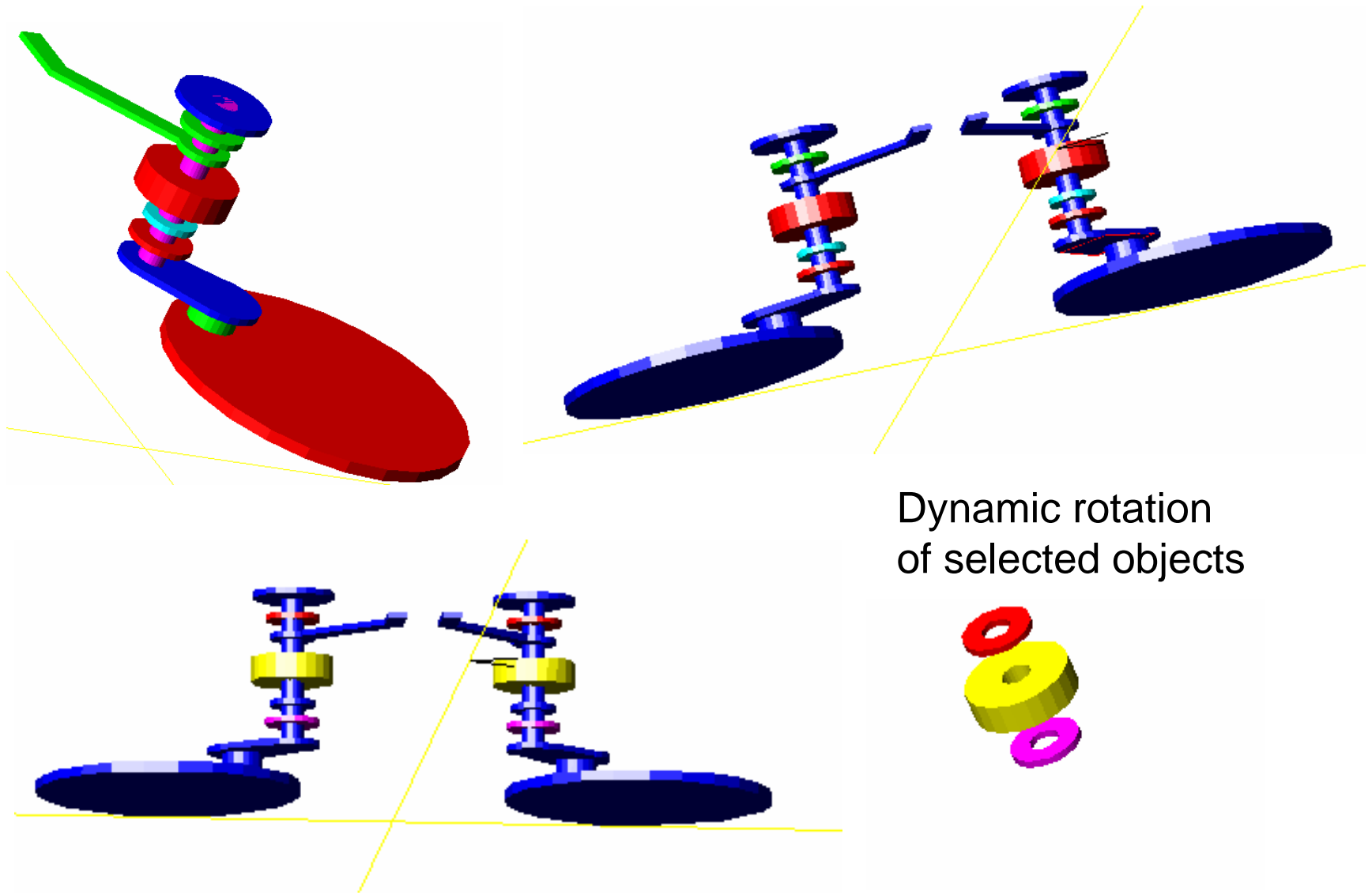
Fast and accurate electromagnetic simulation of arbitrary 3D passive components using FEM

Simulated data

- S-parameters
- Electric and magnetic fields
- Multi-mode impedance and propagation constants



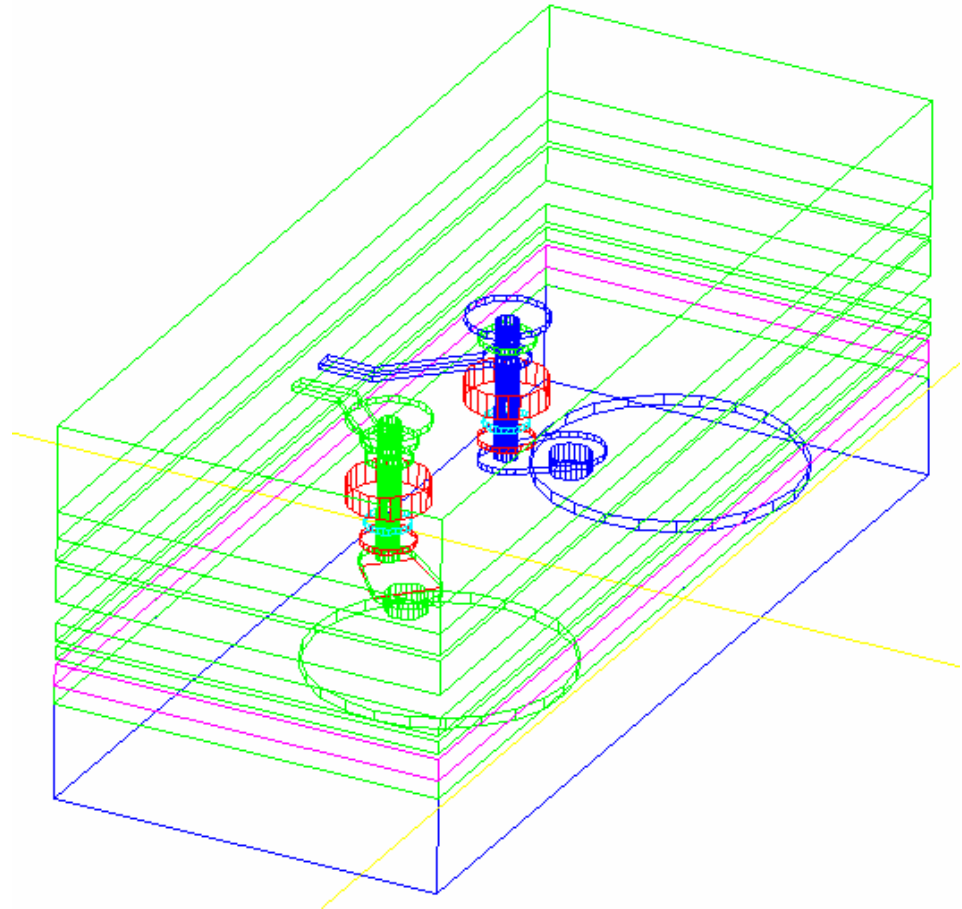
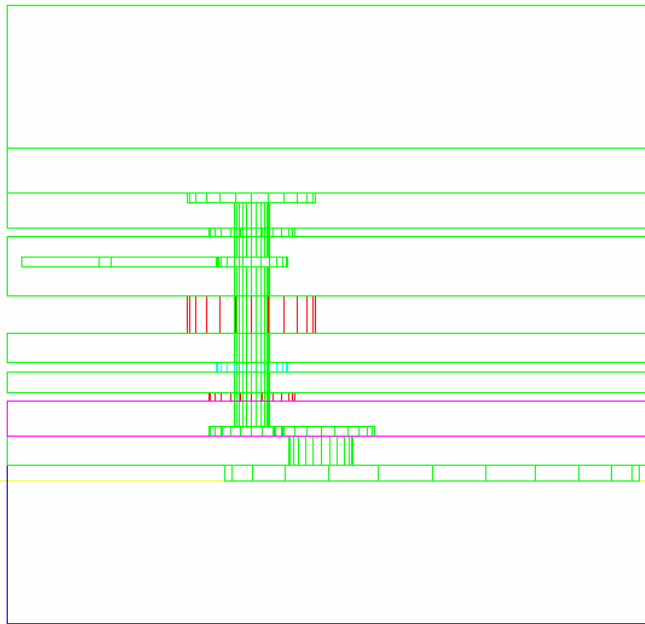
# Differential Via Modeling Using EMDS



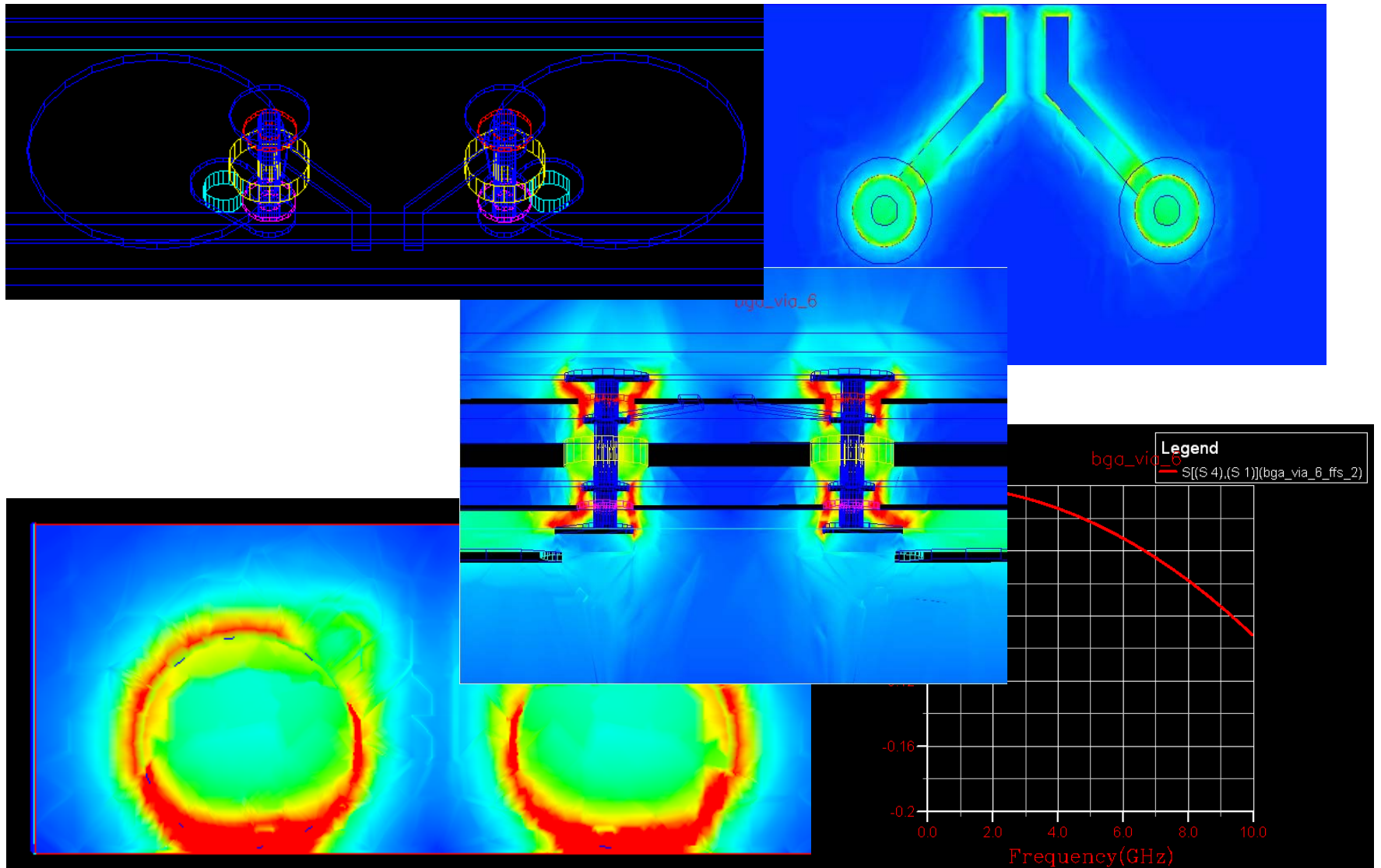
Dynamic rotation  
of selected objects



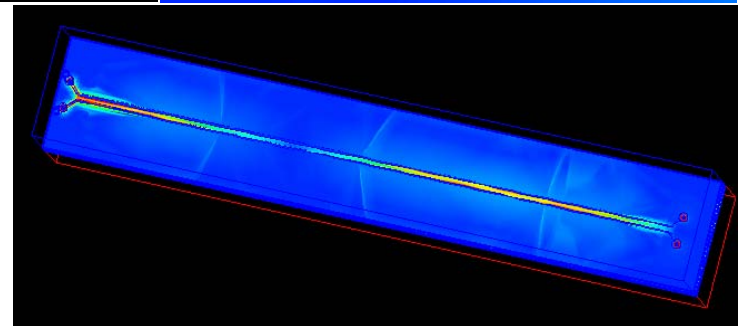
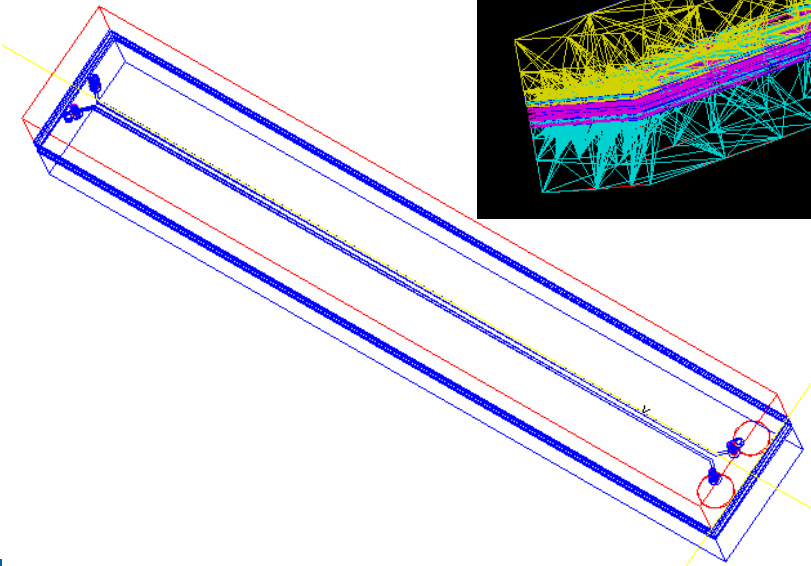
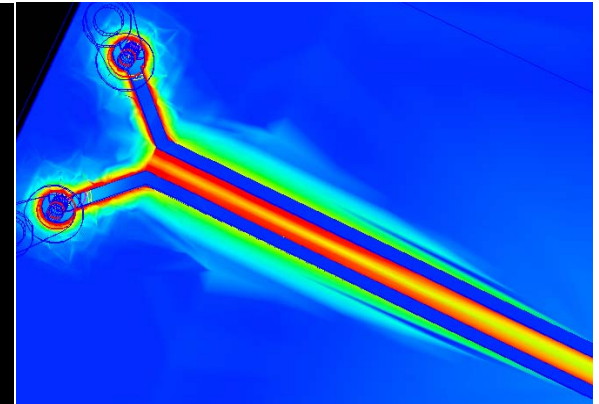
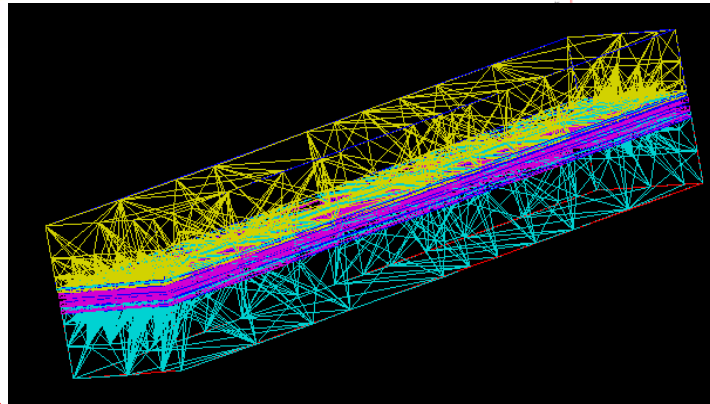
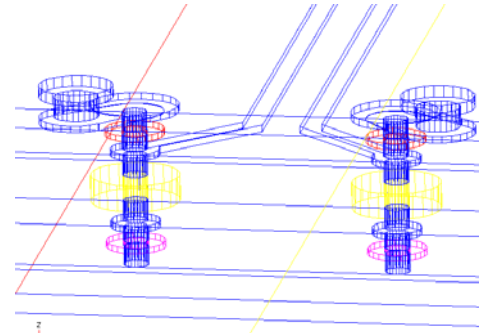
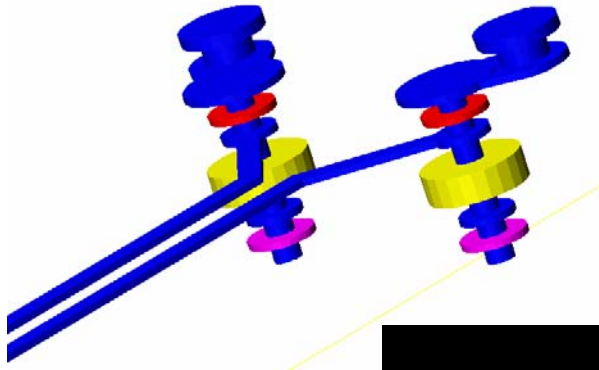
# Cross-Sectional View with Dielectric Layers Defined



# Data Visualization

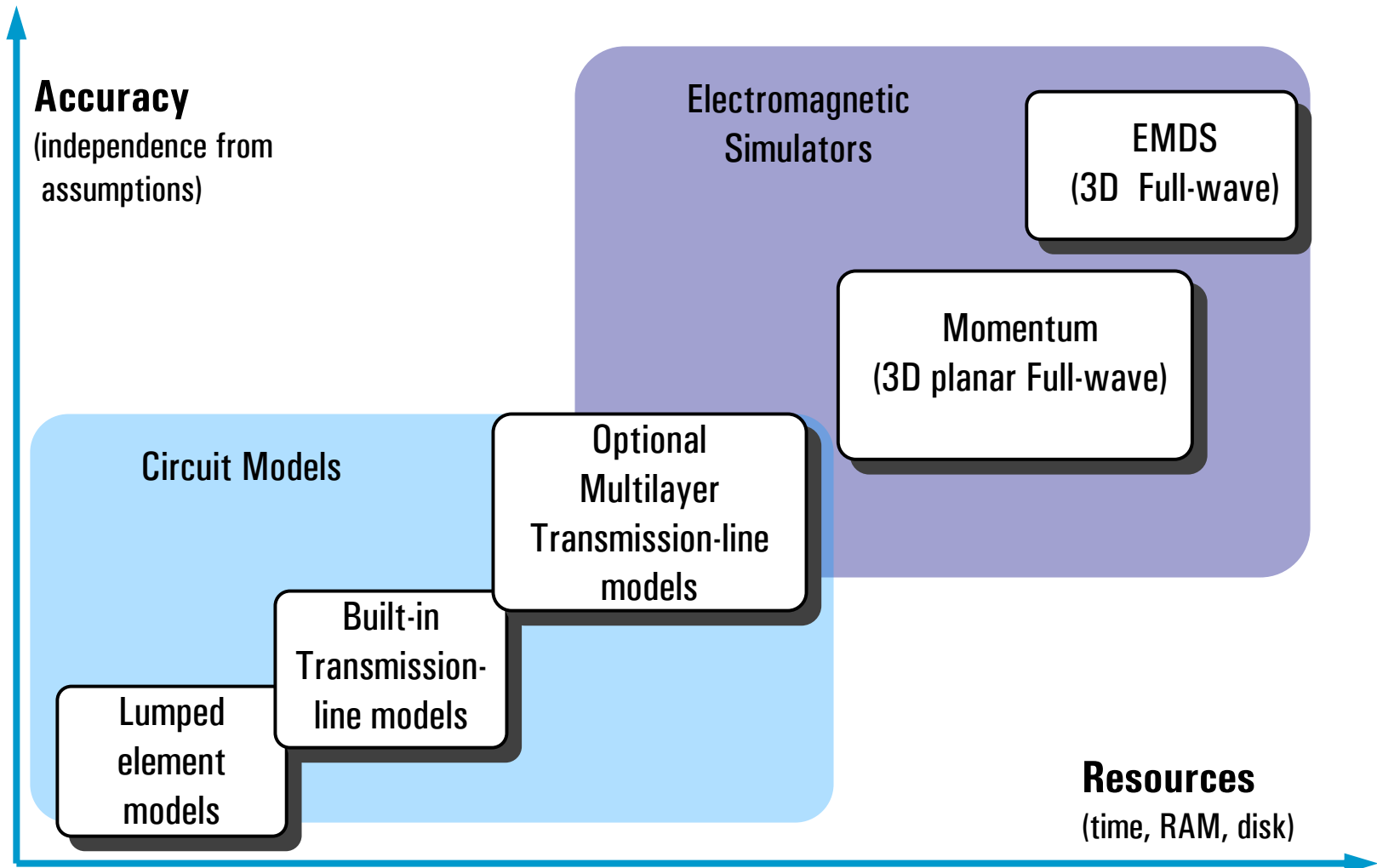


# HyperBGA Differential Trace Analysis using EMDS



# Where you need Momentum and where EMDS?

## Continuum of Speed vs. Accuracy



# What's in ADS for High Speed Digital

## *"Expands SI Horizon"*

### 1. Leading Simulation Technology

solves new problems and gives you a design advantage

### 2. Accurate Models

conquer existing problems so you are confident that designs will work the first time.

### 3. Accessibility & Flow Integration

within your Design Flow puts Agilent tools closer to the design problems

### 4. Usability and Quality

frees your creativity and makes the most of your effort





# DesignCon 2007

Subject to approval

- Calibration Techniques for 4-port and 12-port Differential PCB Structures *by Heidi Barnes et al.- Verigy Inc.*
- DDJ(Data Dependent Jitter) Predictor Implemented on Agilent ADS(Advanced Design System) *by LEO Li - Agilent Technologies*
- Dynamic Transient Load Emulator: The Power Validation of a Network Processor Package *by Straty Argyrakis- CISCO*
- Determining Jitter and Voltage Margin Compliance in Equalized High-Loss Systems using S-parameter, Behavioral, and Circuit-Level Models *by Tom Dagostino et al.– Teraspeed Consulting Group LLC*



***“Expands SI Horizon”***



**...Using ADS Unified Environment for Signal Integrity**